



PCA9531

8-bit I²C-bus LED dimmer

Rev. 06 — 19 February 2009

Product data sheet

1. General description

The PCA9531 is an 8-bit I²C-bus and SMBus I/O expander optimized for dimming LEDs in 256 discrete steps for Red/Green/Blue (RGB) color mixing and back light applications.

The PCA9531 contains an internal oscillator with two user programmable blink rates and duty cycles coupled to the output PWM. The LED brightness is controlled by setting the blink rate high enough (> 100 Hz) that the blinking cannot be seen and then using the duty cycle to vary the amount of time the LED is on and thus the average current through the LED.

The initial setup sequence programs the two blink rates/duty cycles for each individual PWM. From then on, only one command from the bus master is required to turn individual LEDs ON, OFF, BLINK RATE 1 or BLINK RATE 2. Based on the programmed frequency and duty cycle, BLINK RATE 1 and BLINK RATE 2 will cause the LEDs to appear at a different brightness or blink at periods up to 1.69 second. The open-drain outputs directly drive the LEDs with maximum output sink current of 25 mA per bit and 100 mA per package.

To blink LEDs at periods greater than 1.69 second the bus master (MCU, MPU, DSP, chip set, etc.) must send repeated commands to turn the LED on and off as is currently done when using normal I/O expanders like the NXP Semiconductors PCF8574 or PCA9554. Any bits not used for controlling the LEDs can be used for General Purpose parallel Input/Output (GPIO) expansion, which provides a simple solution when additional I/O is needed for ACPI power switches, sensors, push-buttons, alarm monitoring, fans, etc.

The active LOW hardware reset pin (**RESET**) and Power-On Reset (POR) initializes the registers to their default state causing the bits to be set HIGH (LED off).

Three hardware address pins on the PCA9531 allow eight devices to operate on the same bus.

2. Features

- Eight LED drivers (on, off, flashing at a programmable rate)
- Two selectable, fully programmable blink rates (frequency and duty cycle) between 0.59 Hz and 152 Hz (1.69 second and 6.58 milliseconds)
- 256 brightness steps
- Input/outputs not used as LED drivers can be used as regular GPIOs
- Internal oscillator requires no external components
- I²C-bus interface logic compatible with SMBus
- Internal power-on reset



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- Noise filter on SCL/SDA inputs
- Active LOW reset input
- Eight open-drain outputs directly drive LEDs to 25 mA
- Edge rate control on outputs
- No glitch on power-up
- Supports hot insertion
- Low standby current
- Operating power supply voltage range of 2.3 V to 5.5 V
- 0 Hz to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114, 150 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101
- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA
- Packages offered: SO16, TSSOP16, HVQFN16

3. Ordering information

Table 1. Ordering information

 $T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$.

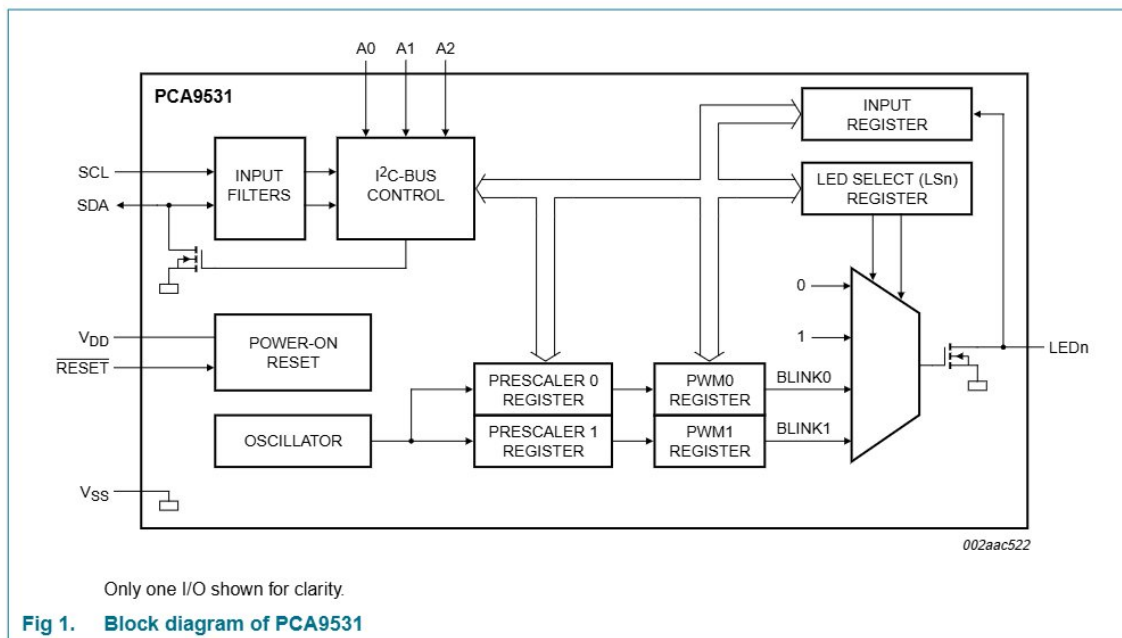
Type number	Topside mark	Package		
		Name	Description	Version
PCA9531D	PCA9531D	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
PCA9531PW	PCA9531	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
PCA9531BS	9531	HVQFN16	plastic thermal enhanced very thin quad flat package; no leads; 16 terminals; body 4 × 4 × 0.85 mm	SOT629-1

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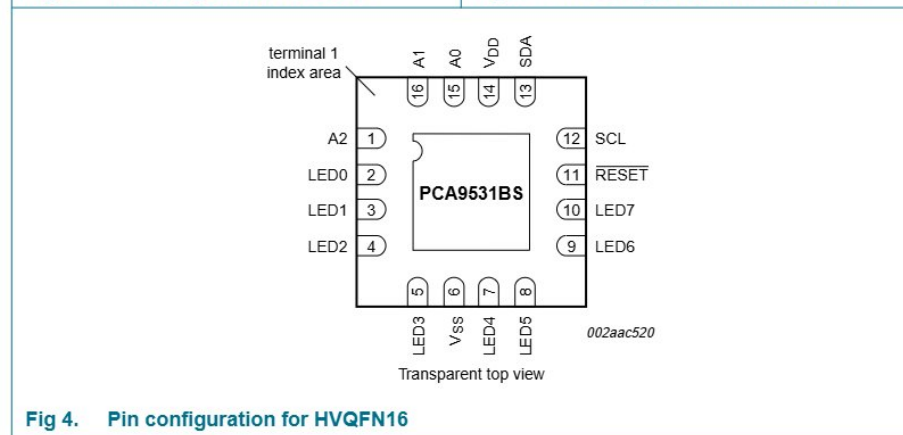
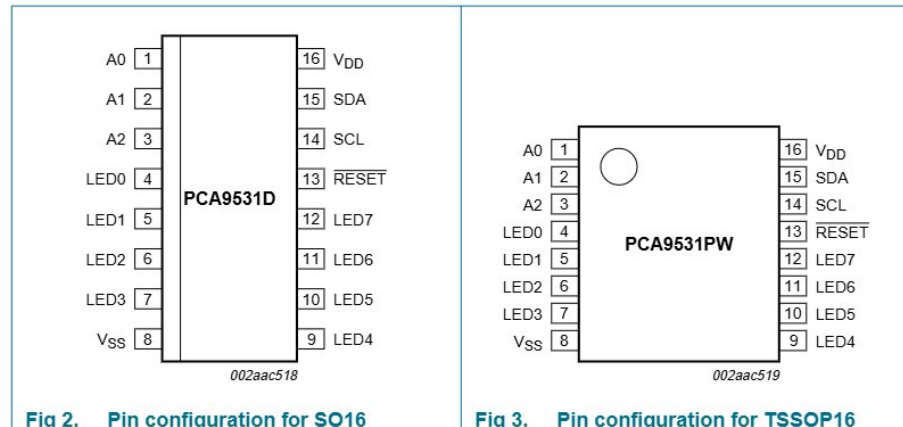
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4. Block diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin		Description
	SO16, TSSOP16	HVQFN16	
A0	1	15	address input 0
A1	2	16	address input 1
A2	3	1	address input 2
LED0	4	2	LED driver 0
LED1	5	3	LED driver 1
LED2	6	4	LED driver 2
LED3	7	5	LED driver 3

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Table 2. Pin description ...continued

Symbol	Pin		Description
	SO16, TSSOP16	HVQFN16	
V _{SS}	8	6[1]	supply ground
LED4	9	7	LED driver 4
LED5	10	8	LED driver 5
LED6	11	9	LED driver 6
LED7	12	10	LED driver 7
RESET	13	11	reset input (active LOW)
SCL	14	12	serial clock line
SDA	15	13	serial data line
V _{DD}	16	14	supply voltage

[1] HVQFN16 package die supply ground is connected to both V_{SS} pin and exposed center pad. V_{SS} pin must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board level performance, the exposed pad needs to be soldered to the board using a corresponding thermal pad on the board and for proper heat conduction through the board, thermal vias need to be incorporated in the PCB in the thermal pad region.

6. Functional description

Refer to [Figure 1 “Block diagram of PCA9531”](#).

6.1 Device address

Following a START condition, the bus master must output the address of the slave it is accessing. The address of the PCA9531 is shown in [Figure 5](#). To conserve power, no internal pull-up resistors are incorporated on the hardware selectable address pins and they must be pulled HIGH or LOW.

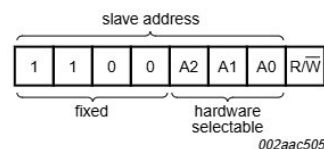


Fig 5. PCA9531 slave address

The last bit of the address byte defines the operation to be performed. When set to logic 1 a read is selected, while a logic 0 selects a write operation.

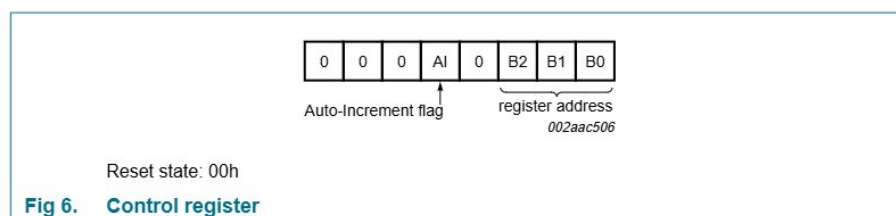
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6.2 Control register

Following the successful acknowledgement of the slave address, the bus master will send a byte to the PCA9531, which will be stored in the Control register.



The lowest 3 bits are used as a pointer to determine which register will be accessed.

If the Auto-Increment flag is set, the three low order bits of the Control register are automatically incremented after a read or write. This allows the user to program the registers sequentially. The contents of these bits will rollover to '000' after the last register is accessed.

When Auto-Increment flag is set (AI = 1) and a read sequence is initiated, the sequence must start by reading a register different from the Input register (B2 B1 B0 ≠ 0 0 0).

Only the 3 least significant bits are affected by the AI flag. Unused bits must be programmed with zeroes.

6.2.1 Control register definition

Table 3. Register summary

B2	B1	B0	Symbol	Access	Description
0	0	0	INPUT	read only	input register
0	0	1	PSC0	read/write	frequency prescaler 0
0	1	0	PWM0	read/write	PWM register 0
0	1	1	PSC1	read/write	frequency prescaler 1
1	0	0	PWM1	read/write	PWM register 1
1	0	1	LS0	read/write	LED0 to LED3 selector
1	1	0	LS1	read/write	LED4 to LED7 selector

6.3 Register descriptions

6.3.1 INPUT - Input register

The INPUT register reflects the state of the device pins. Writes to this register will be acknowledged but will have no effect.

Table 4. INPUT - Input register description

Bit	7	6	5	4	3	2	1	0
Symbol	LED7	LED6	LED5	LED4	LED3	LED2	LED1	LED0
Default	X	X	X	X	X	X	X	X

Remark: The default value 'X' is determined by the externally applied logic level (normally logic 1) when used for directly driving LED with pull-up to V_{DD}.

6.3.2 PSC0 - Frequency Prescaler 0

PSC0 is used to program the period of the PWM output.

The period of BLINK0 = (PSC0 + 1) / 152.

Table 5. PSC0 - Frequency Prescaler 0 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PSC0[7]	PSC0[6]	PSC0[5]	PSC0[4]	PSC0[3]	PSC0[2]	PSC0[1]	PSC0[0]
Default	1	1	1	1	1	1	1	1

6.3.3 PWM0 - Pulse Width Modulation 0

The PWM0 register determines the duty cycle of BLINK0. The outputs are LOW (LED on) when the count is less than the value in PWM0 and HIGH (LED off) when it is greater. If PWM0 is programmed with 00h, then the PWM0 output is always HIGH (LED off).

The duty cycle of BLINK0 = PWM0 / 256.

Table 6. PWM0 - Pulse Width Modulation 0 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PWM0 [7]	PWM0 [6]	PWM0 [5]	PWM0 [4]	PWM0 [3]	PWM0 [2]	PWM0 [1]	PWM0 [0]
Default	1	0	0	0	0	0	0	0

6.3.4 PSC1 - Frequency Prescaler 1

PSC1 is used to program the period of the PWM output.

The period of BLINK1 = (PSC1 + 1) / 152.

Table 7. PSC1 - Frequency Prescaler 1 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PSC1[7]	PSC1[6]	PSC1[5]	PSC1[4]	PSC1[3]	PSC1[2]	PSC1[1]	PSC1[0]
Default	0	0	0	0	0	0	0	0

6.3.5 PWM1 - Pulse Width Modulation 1

The PWM1 register determines the duty cycle of BLINK1. The outputs are LOW (LED on) when the count is less than the value in PWM1 and HIGH (LED off) when it is greater. If PWM1 is programmed with 00h, then the PWM1 output is always HIGH (LED off).

The duty cycle of BLINK1 = PWM1 / 256.

Table 8. PWM1 - Pulse Width Modulation 1 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PWM1 [7]	PWM1 [6]	PWM1 [5]	PWM1 [4]	PWM1 [3]	PWM1 [2]	PWM1 [1]	PWM1 [0]
Default	1	0	0	0	0	0	0	0

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6.3.6 LS0 to LS1 - LED selector registers

The LSn LED select registers determine the source of the LED data.

00 = output is set high-impedance (LED off; default)

01 = output is set LOW (LED on)

10 = output blinks at PWM0 rate

11 = output blinks at PWM1 rate

Table 9. LS0 to LS1 - LED selector registers bit description

Legend: * default value.

Register	Bit	Value	Description
LS0 - LED0 to LED3 selector			
LS0	7:6	00*	LED3 selected
	5:4	00*	LED2 selected
	3:2	00*	LED1 selected
	1:0	00*	LED0 selected
LS1 - LED4 to LED7 selector			
LS1	7:6	00*	LED7 selected
	5:4	00*	LED6 selected
	3:2	00*	LED5 selected
	1:0	00*	LED4 selected

6.4 Pins used as GPIOs

LED pins not used to control LEDs can be used as General Purpose I/Os (GPIOs).

For use as input, set LEDn to high-impedance (00) and then read the pin state via the Input register.

For use as output, connect external pull-up resistor to the pin and size it according to the DC recommended operating characteristics. LEDn output pin is HIGH when the output is programmed as high-impedance, and LOW when the output is programmed LOW through the 'LED selector' register. The output can be pulse-width controlled when PWM0 or PWM1 are used.

6.5 Power-on reset

When power is applied to V_{DD} , an internal Power-On Reset (POR) holds the PCA9531 in a reset condition until V_{DD} has reached V_{POR} . At that point, the reset condition is released and the PCA9531 registers are initialized to their default states, all the outputs in the OFF state. Thereafter, V_{DD} must be lowered below 0.2 V to reset the device.

6.6 External RESET

A reset can be accomplished by holding the RESET pin LOW for a minimum of $t_{w(rst)}$. The PCA9531 registers and I²C-bus state machine will be held in their default states until the RESET input is once again HIGH.

This input requires a pull-up resistor to V_{DD} if no active connection is used.

7. Characteristics of the I²C-bus

The I²C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

7.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see [Figure 7](#)).

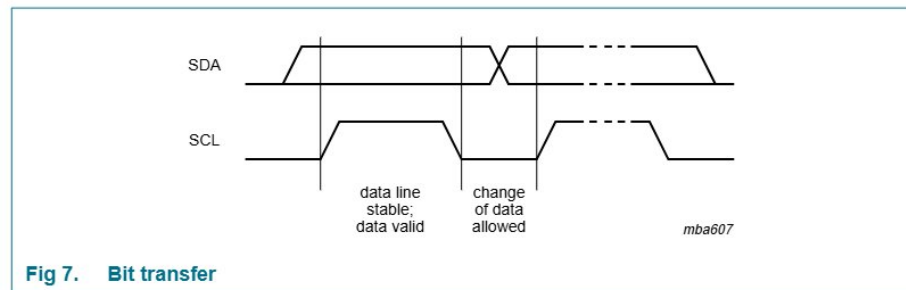


Fig 7. Bit transfer

7.1.1 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P) (see [Figure 8](#)).

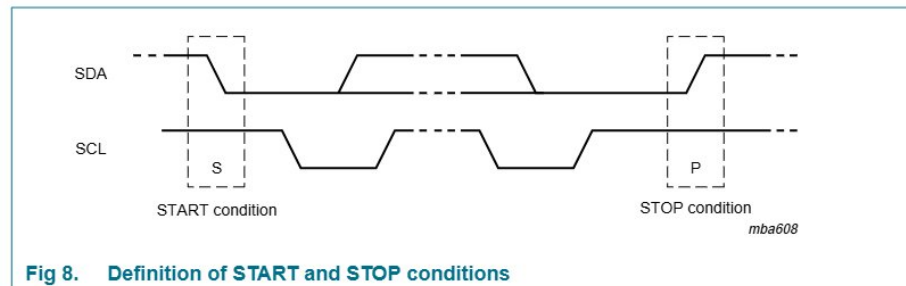


Fig 8. Definition of START and STOP conditions

7.2 System configuration

A device generating a message is a 'transmitter'; a device receiving is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves' (see [Figure 9](#)).

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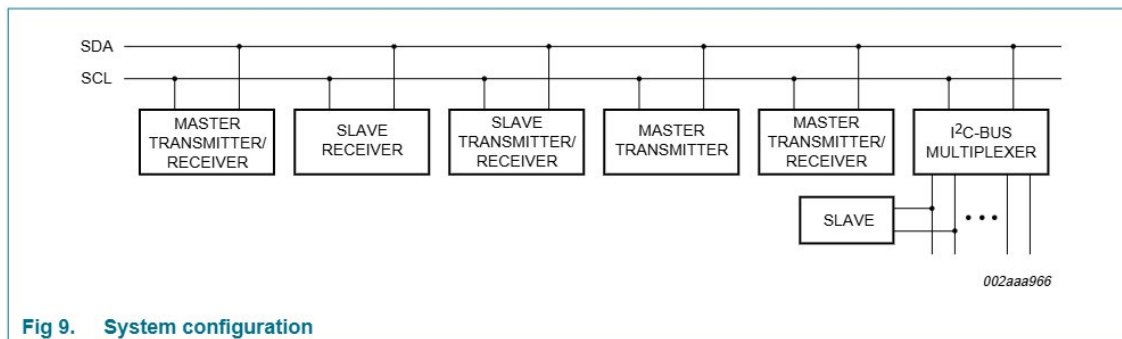


Fig 9. System configuration

7.3 Acknowledge

The number of data bytes transferred between the START and the STOP conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter, whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse; set-up and hold times must be taken into account.

A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

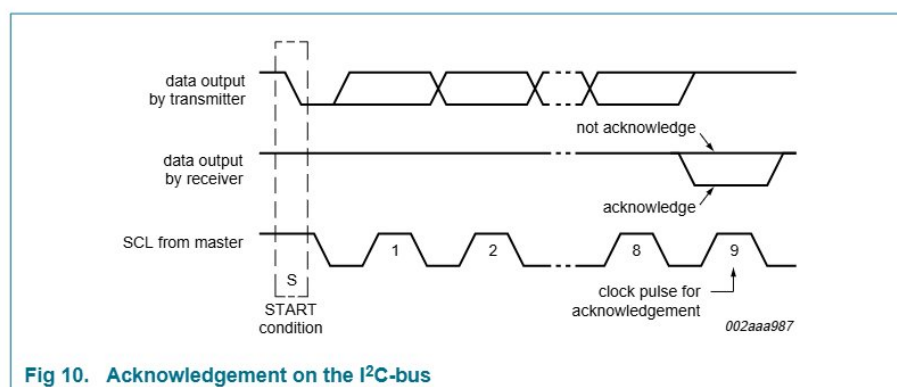


Fig 10. Acknowledgement on the I²C-bus

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7.4 Bus transactions

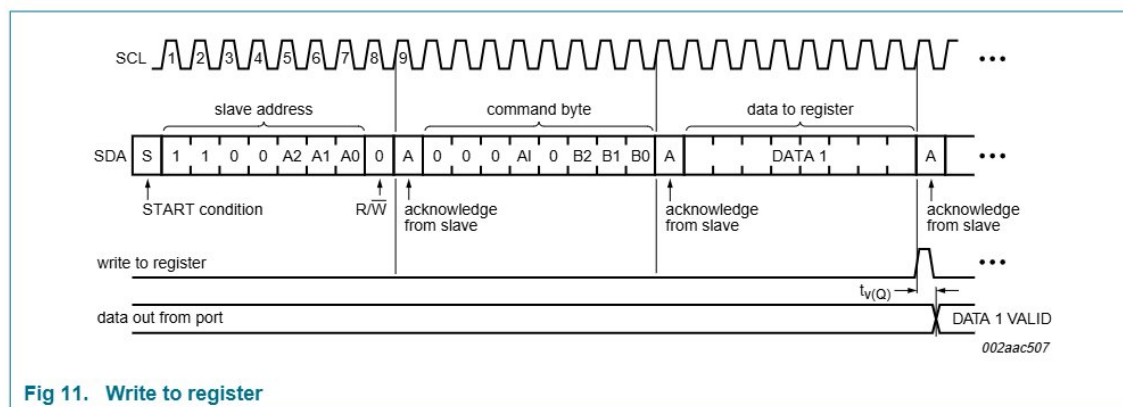


Fig 11. Write to register

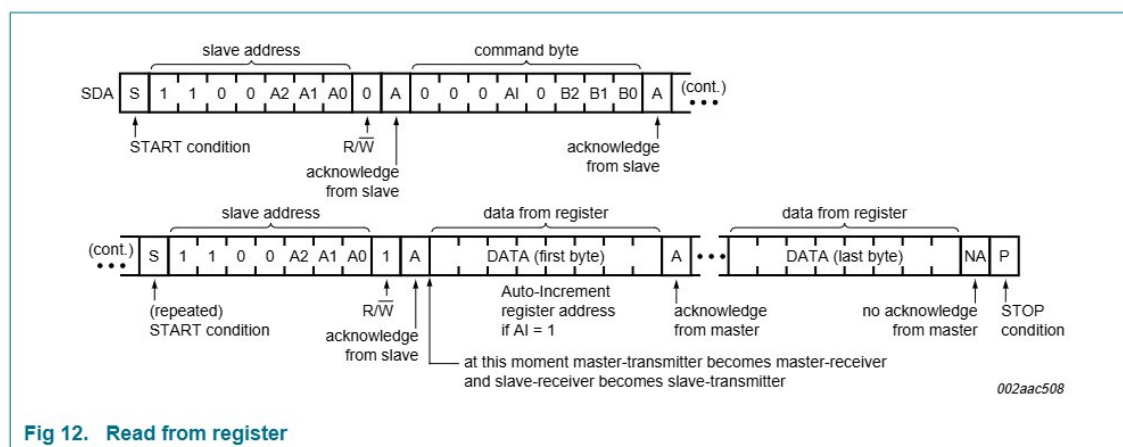


Fig 12. Read from register

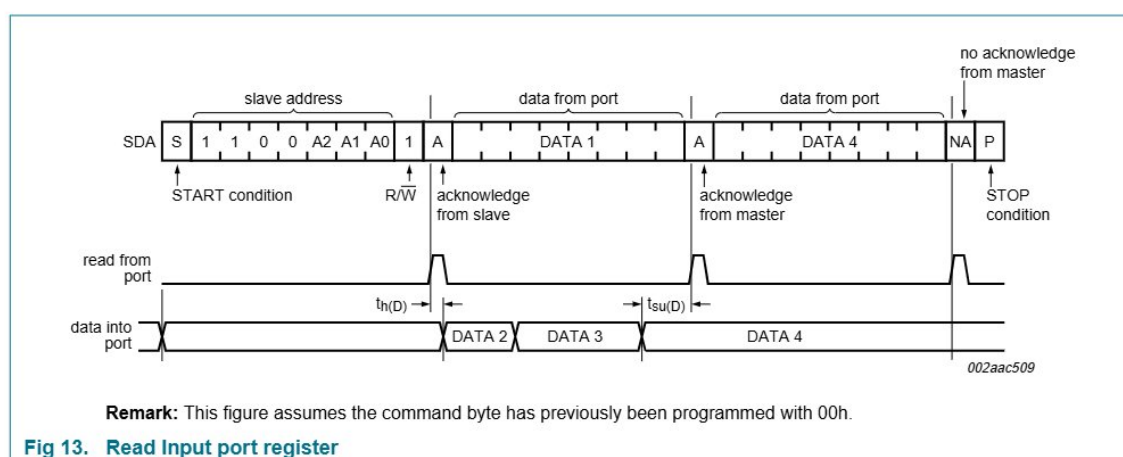


Fig 13. Read Input port register

8. Application design-in information

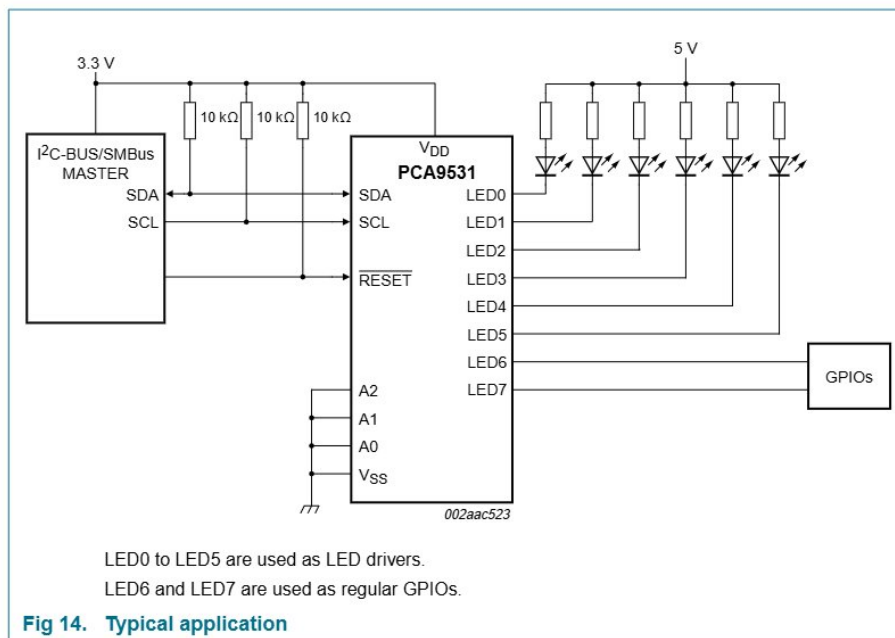


Fig 14. Typical application

8.1 Minimizing I_{DD} when the I/Os are used to control LEDs

When the I/Os are used to control LEDs, they are normally connected to V_{DD} through a resistor as shown in Figure 14. Since the LED acts as a diode, when the LED is off the I/O V_I is about 1.2 V less than V_{DD}. The supply current, I_{DD}, increases as V_I becomes lower than V_{DD} and is specified as ΔI_{DD} in Table 12 "Static characteristics".

Designs needing to minimize current consumption, such as battery power applications, should consider maintaining the I/O pins greater than or equal to V_{DD} when the LED is off. Figure 15 shows a high value resistor in parallel with the LED. Figure 16 shows V_{DD} less than the LED supply voltage by at least 1.2 V. Both of these methods maintain the I/O V_I at or above V_{DD} and prevents additional supply current consumption when the LED is off.

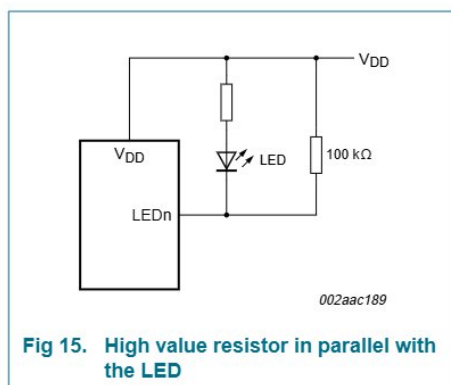


Fig 15. High value resistor in parallel with the LED

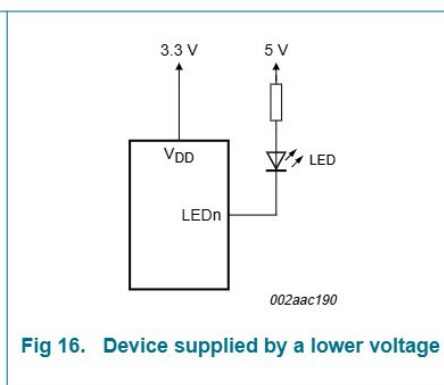


Fig 16. Device supplied by a lower voltage

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8.2 Programming example

The following example will show how to set LED0 to LED3 on. It will then set LED4 and LED5 to blink at 1 Hz at a 50 % duty cycle. LED6 and LED7 will be set to be dimmed at 25 % of their maximum brightness (duty cycle = 25 %).

Table 10. Programming PCA9531

Program sequence	I ² C-bus
START	S
PCA9531 address with A0 to A2 = LOW	C0h
PSC0 subaddress + Auto-Increment	11h
Set prescaler PSC0 to achieve a period of 1 second: $\text{Blink period} = 1 = \frac{\text{PSC0} + 1}{152}$	97h
PSC0 = 151	
Set PWM0 duty cycle to 50 %: $\frac{\text{PWM0}}{256} = 0.5$	80h
PWM0 = 128	
Set prescaler PCS1 to dim at maximum frequency: $\text{Blink period} = \text{max}$	00h
PCS1 = 0	
Set PWM1 output duty cycle to 25 %: $\frac{\text{PWM1}}{256} = 0.25$	40h
PWM1 = 64	
Set LED0 to LED3 on	55h
Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1	FAh
STOP	P

9. Limiting values

Table 11. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+6.0	V
V _{I/O}	voltage on an input/output pin		V _{SS} - 0.5	5.5	V
I _{O(LEDn)}	output current on pin LEDn		-	±25	mA
I _{SS}	ground supply current		-	200	mA
P _{tot}	total power dissipation		-	400	mW
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature	operating	-40	+85	°C

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10. Static characteristics

Table 12. Static characteristics

 $V_{DD} = 2.3\text{ V to }5.5\text{ V}$; $V_{SS} = 0\text{ V}$; $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ ^[1]	Max	Unit
Supplies						
V_{DD}	supply voltage		2.3	-	5.5	V
I_{DD}	supply current	operating mode; $V_{DD} = 5.5\text{ V}$; $V_I = V_{DD}$ or V_{SS} ; $f_{SCL} = 100\text{ kHz}$	-	350	500	μA
I_{stb}	standby current	Standby mode; $V_{DD} = 5.5\text{ V}$; $V_I = V_{DD}$ or V_{SS} ; $f_{SCL} = 0\text{ kHz}$	-	1.9	5.0	μA
Δ_{DD}	additional quiescent supply current	Standby mode; $V_{DD} = 5.5\text{ V}$; LED I/O at $V_I = 4.3\text{ V}$; $f_{SCL} = 0\text{ kHz}$	^[2] -	-	200	μA
V_{POR}	power-on reset voltage	no load; $V_I = V_{DD}$ or V_{SS}	^[3] -	1.7	2.2	V
Input SCL; input/output SDA						
V_{IL}	LOW-level input voltage		-0.5	-	+0.3 V_{DD}	V
V_{IH}	HIGH-level input voltage		0.7 V_{DD}	-	5.5	V
I_{OL}	LOW-level output current	$V_{OL} = 0.4\text{ V}$	3	6.5	-	mA
I_L	leakage current	$V_I = V_{DD} = V_{SS}$	-1	-	+1	μA
C_i	input capacitance	$V_I = V_{SS}$	-	3.7	5	pF
I/Os						
V_{IL}	LOW-level input voltage		-0.5	-	+0.8	V
V_{IH}	HIGH-level input voltage		2.0	-	5.5	V
I_{OL}	LOW-level output current	$V_{OL} = 0.4\text{ V}$				
		$V_{DD} = 2.3\text{ V}$	^[4] 9	-	-	mA
		$V_{DD} = 3.0\text{ V}$	^[4] 12	-	-	mA
		$V_{DD} = 5.0\text{ V}$	^[4] 15	-	-	mA
		$V_{OL} = 0.7\text{ V}$				
		$V_{DD} = 2.3\text{ V}$	^[4] 15	-	-	mA
		$V_{DD} = 3.0\text{ V}$	^[4] 20	-	-	mA
		$V_{DD} = 5.0\text{ V}$	^[4] 25	-	-	mA
I_{LI}	input leakage current	$V_{DD} = 3.6\text{ V}$; $V_I = 0\text{ V}$ or V_{DD}	-1	-	+1	μA
C_{io}	input/output capacitance		-	2.5	5	pF
Select inputs A0, A1, A2; RESET						
V_{IL}	LOW-level input voltage		-0.5	-	+0.8	V
V_{IH}	HIGH-level input voltage	A0; RESET	2.0	-	5.5	V
		A1; A2	2.0	-	$V_{DD} + 0.5$	V
I_{LI}	input leakage current		-1	-	+1	μA
C_i	input capacitance	$V_I = V_{SS}$	-	2.3	5	pF

[1] Typical limits at $V_{DD} = 3.3\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$.[2] Additional current for one LED I/O at a time where $V_I = 4.3\text{ V}$.[3] V_{DD} must be lowered to 0.2 V in order to reset part.

[4] Each I/O must be externally limited to a maximum of 25 mA and the device must be limited to a maximum current of 100 mA.

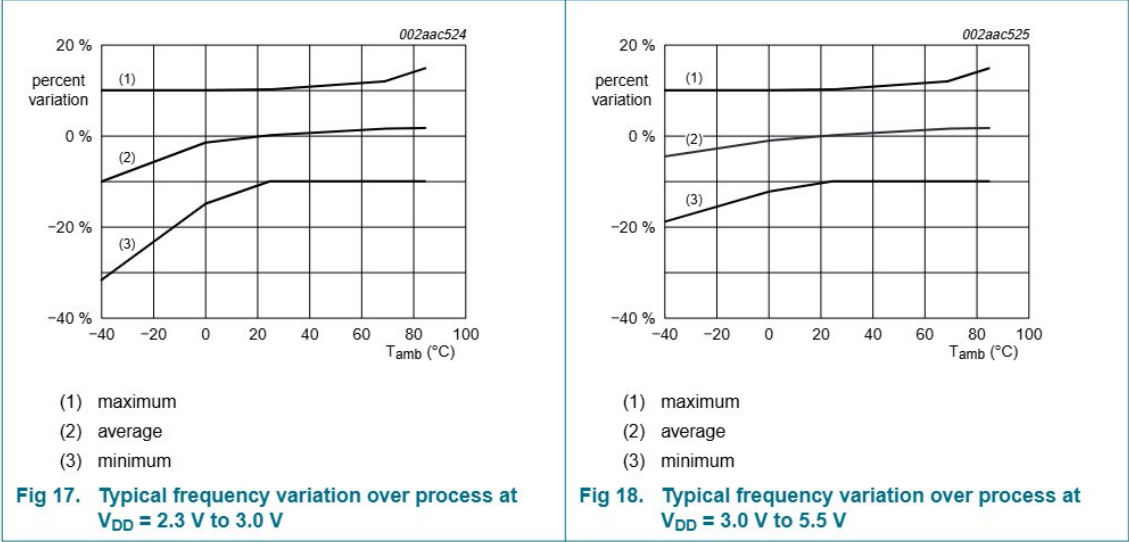
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11. Dynamic characteristics

Table 13. Dynamic characteristics

Symbol	Parameter	Conditions	Standard-mode I ² C-bus		Fast-mode I ² C-bus		Unit
			Min	Max	Min	Max	
f _{SCL}	SCL clock frequency		0	100	0	400	kHz
t _{BUF}	bus free time between a STOP and START condition		4.7	-	1.3	-	∞s
t _{HD,STA}	hold time (repeated) START condition		4.0	-	0.6	-	∞s
t _{SU,STA}	set-up time for a repeated START condition		4.7	-	0.6	-	∞s
t _{SU,STO}	set-up time for STOP condition		4.0	-	0.6	-	∞s
t _{HD,DAT}	data hold time		0	-	0	-	ns
t _{VD,ACK}	data valid acknowledge time		[1]	-	600	-	600 ns
t _{VD,DAT}	data valid time	LOW-level	[2]	-	600	-	600 ns
		HIGH-level	[2]	-	1500	-	600 ns
t _{SU,DAT}	data set-up time		250	-	100	-	ns
t _{LOW}	LOW period of the SCL clock		4.7	-	1.3	-	∞s
t _{HIGH}	HIGH period of the SCL clock		4.0	-	0.6	-	∞s
t _r	rise time of both SDA and SCL signals		-	1000	20 + 0.1C _p [3]	300	ns
t _f	fall time of both SDA and SCL signals		-	300	20 + 0.1C _p [3]	300	ns
t _{SP}	pulse width of spikes that must be suppressed by the input filter		-	50	-	50	ns
Port timing							
t _{V(Q)}	data output valid time		-	200	-	200	ns
t _{SU(D)}	data input set-up time		100	-	100	-	ns
t _{H(D)}	data input hold time		1	-	1	-	∞s
Reset							
t _{W(rst)}	reset pulse width		6	-	6	-	ns
t _{rec(rst)}	reset recovery time		0	-	0	-	ns
t _{rst}	reset time	[4][5]	400	-	400	-	ns

[1] t_{VD,ACK} = time for Acknowledgement signal from SCL LOW to SDA (out) LOW.[2] t_{VD,DAT} = minimum time for SDA data output to be valid following SCL LOW.[3] C_b = total capacitance of one bus line in pF.

[4] Resetting the device while actively communicating on the bus may cause glitches or errant STOP conditions.

[5] Upon reset, the full delay will be the sum of t_{rst} and the RC time constant of the SDA bus.

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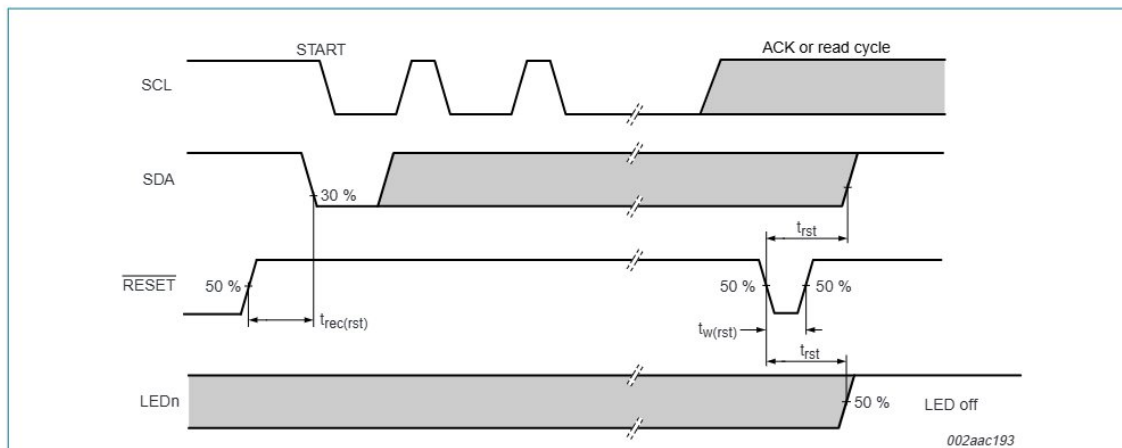


Fig 19. Definition of **RESET** timing

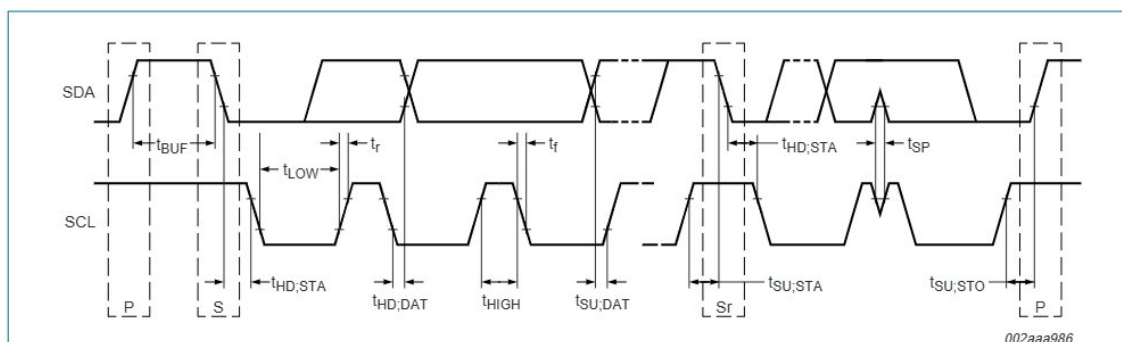
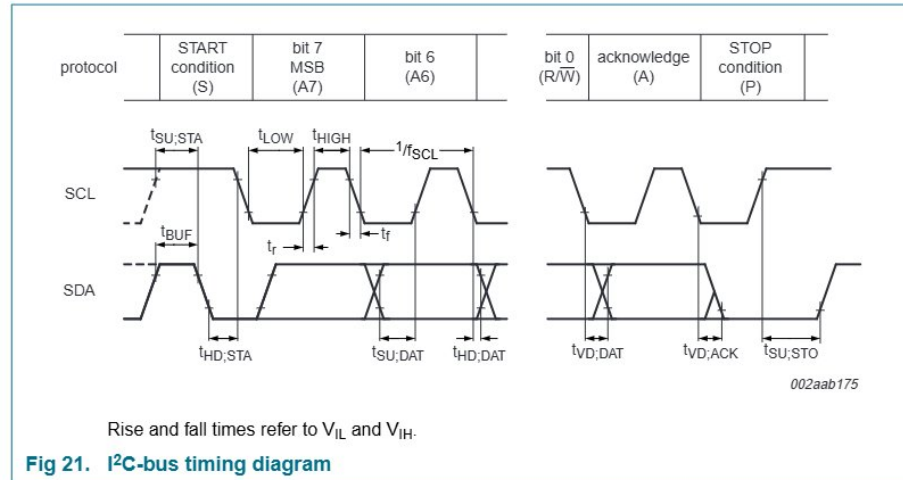


Fig 20. Definition of timing

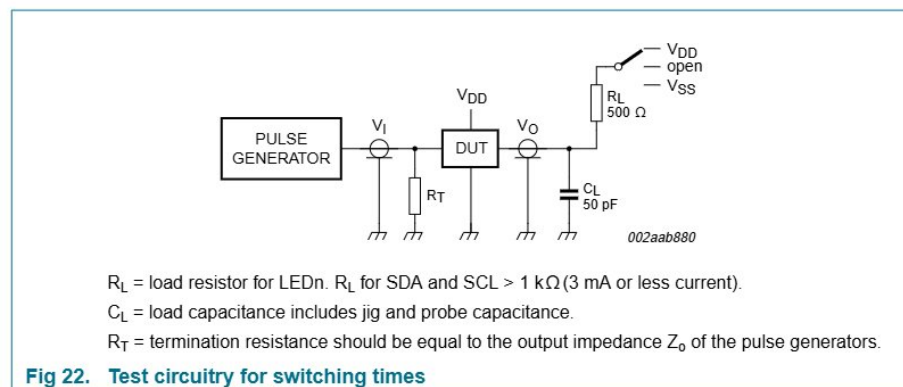
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12. Test information



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13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

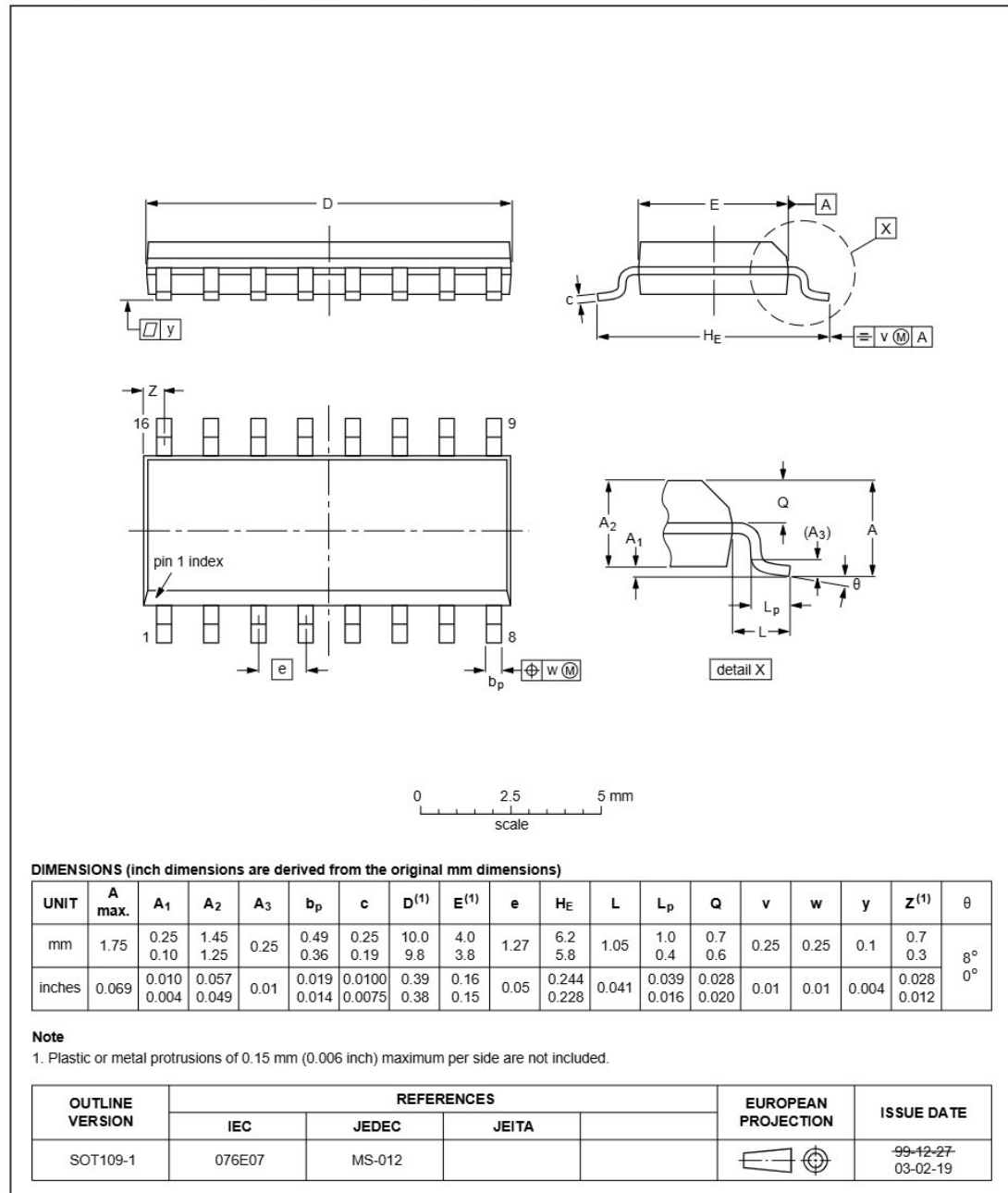


Fig 23. Package outline SOT109-1 (SO16)

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

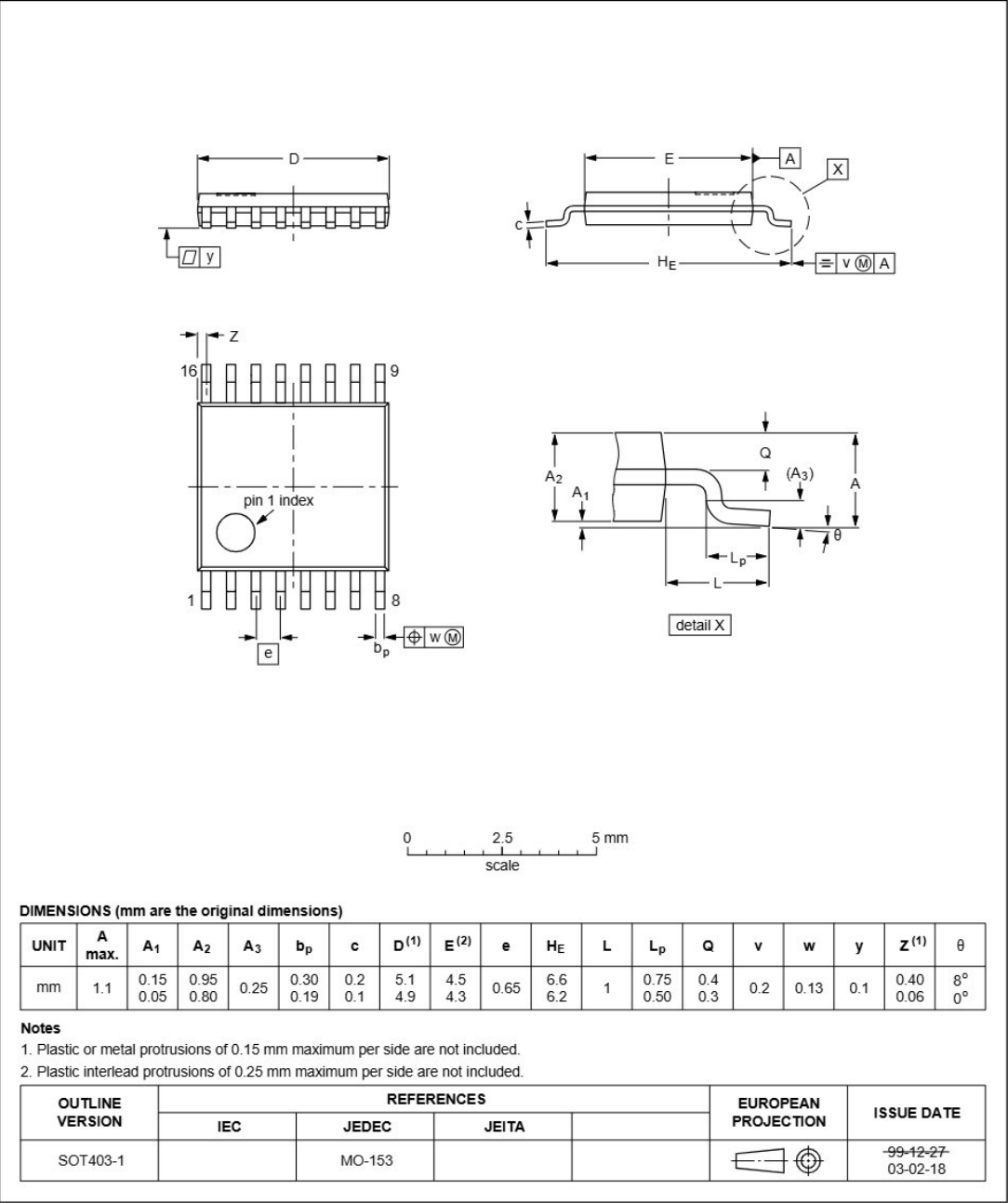


Fig 24. Package outline SOT403-1 (TSSOP16)

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HVQFN16: plastic thermal enhanced very thin quad flat package; no leads;
16 terminals; body 4 x 4 x 0.85 mm

SOT629-1

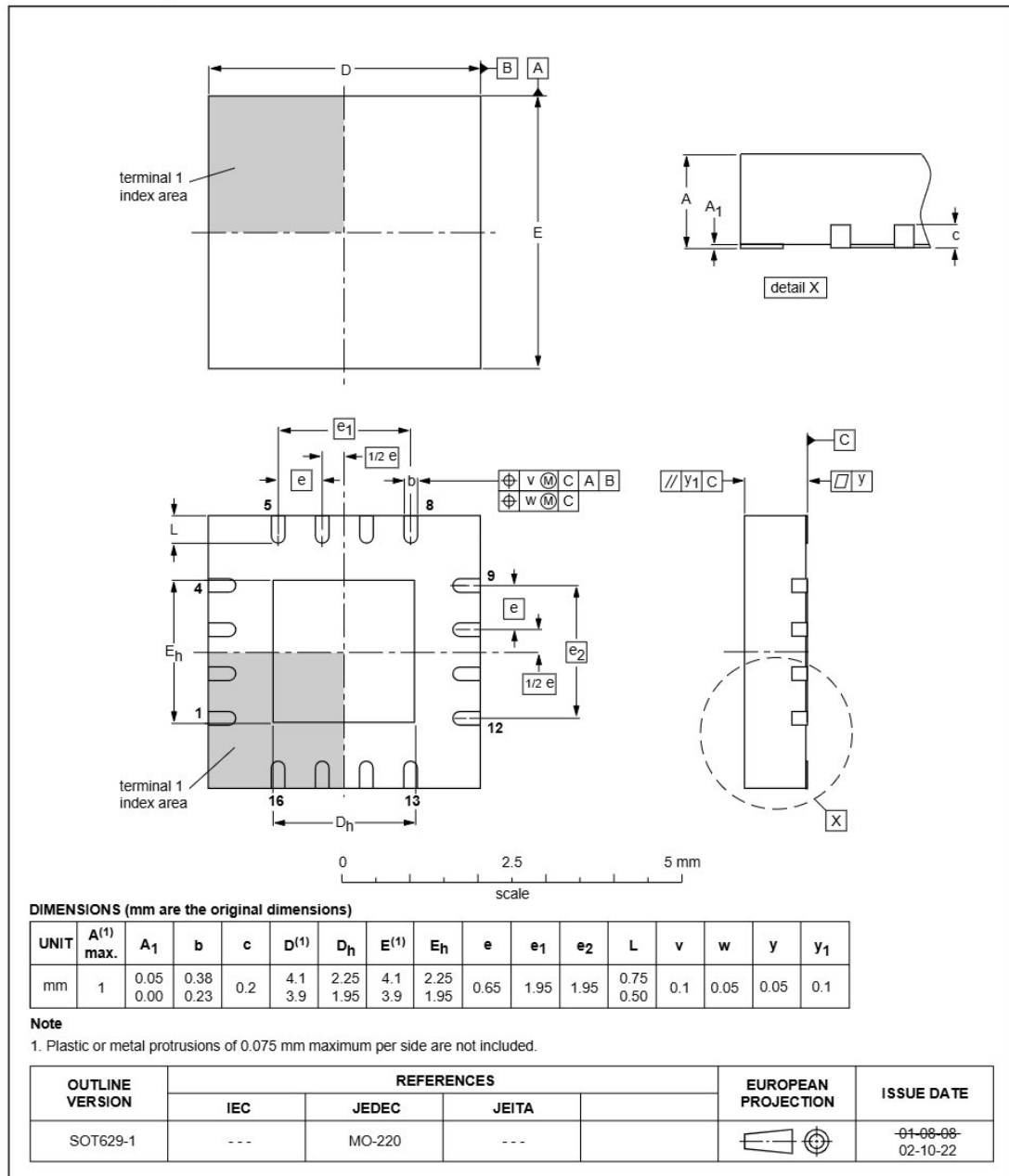


Fig 25. Package outline SOT629-1 (HVQFN16)

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14. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling ensure that the appropriate precautions are taken as described in *JESD625-A* or equivalent standards.

15. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

15.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

15.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

15.3 Wave soldering

Key characteristics in wave soldering are:

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- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

15.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see [Figure 26](#)) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with [Table 14](#) and [15](#)

Table 14. SnPb eutectic process (from J-STD-020C)

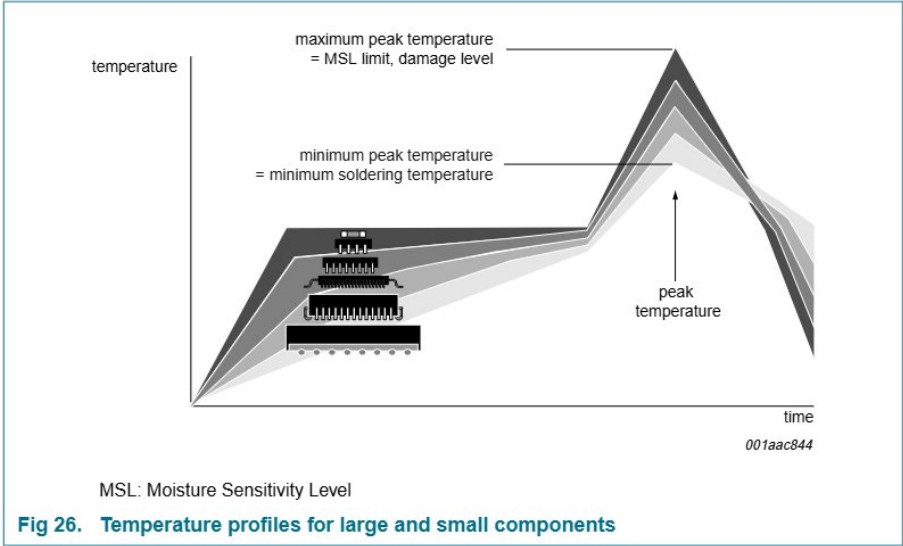
Package thickness (mm)	Package reflow temperature (°C)	
	Volume (mm ³)	
	< 350	≥350
< 2.5	235	220
≥2.5	220	220

Table 15. Lead-free process (from J-STD-020C)

Package thickness (mm)	Package reflow temperature (°C)		
	Volume (mm ³)		
	< 350	350 to 2000	> 2000
< 1.6	260	260	260
1.6 to 2.5	260	250	245
> 2.5	250	245	245

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see [Figure 26](#).



For further information on temperature profiles, refer to Application Note AN10365 “Surface mount reflow soldering description”.

16. Abbreviations

Table 16. Abbreviations

Acronym	Description
CDM	Charged Device Model
DSP	Digital Signal Processor
DUT	Device Under Test
ESD	ElectroStatic Discharge
GPIO	General Purpose Input/Output
HBM	Human Body Model
I ² C-bus	Inter-Integrated Circuit bus
LED	Light Emitting Diode
MCU	Microcontroller
MM	Machine Model
MPU	Microprocessor
POR	Power-On Reset
RC	Resistor-Capacitor network
SMBus	System Management Bus

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17. Revision history

Table 17. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCA9531_6	20090219	Product data sheet	-	PCA9531_5
Modifications:				
- Type number PCA9531BS3 is withdrawn, and is deleted from this data sheet Section 2 "Features", last bullet item: deleted "(SOT629-1 and SOT758-1 versions)" Section 3 "Ordering information": type number PCA9531BS3 removed from table Section 5.1 "Pinning": deleted HVQFN16 (SOT758-1) pin configuration Section 13 "Package outline": deleted package outline SOT758-1 Table 12 "Static characteristics": - Max value for I_{std} changed from "3.0 μA" to "5.0 μA" - Max value for Δ_{DD} changed from "800 μA" to "200 μA" - Added (new) Table note [2] and its reference at Δ_{DD} - Conditions for Δ_{DD} changed from "every LED I/O at $V_I = 4.3$ V" to "LED I/O at $V_I = 4.3$ V" - under sub-section "I/Os", changed symbol from "I_L" (input leakage current) to "I_{LI}" - Updated soldering information				
PCA9531_5	20070912	Product data sheet	-	PCA9531_4
PCA9531_4	20070226	Product data sheet	-	PCA9531_3
PCA9531_3	20061102	Product data sheet	-	PCA9531_2
PCA9531_2 (9397 750 13689)	20041001	Product data sheet	-	PCA9531_1
PCA9531_1 (9397 750 12292)	20031110	Product data	853-2407 30411 (20030906)	-

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18. Legal information

18.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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